



April 2018

Dear Martin,

There were several industry events during April that kept the Highcon team busy. And May will be no different. See below for more details of upcoming opportunities to see what Highcon digital cutting and creasing can do.

Fresh Paint Exhibition

The annual Fresh Paint exhibit, held this year in the Convention Center in Tel Aviv provides a point of view on current state of affairs in local art and design scenes through a special decade exhibition, selected projects by galleries and art institutions, the up-coming independent artist's greenhouse, the video greenhouse, and a presentation of Israel finest product designers.



This unique project by Pulp presents a paper design research and work process, in collaboration with Highcon Systems together with Ilan Print. The outcomes of the process – limited edition 3D desk objects – recount the story of the development process.

Perforations and Zippers

We all know that perforations are a useful yet difficult application that can be affected by the substrates they are performed on. We want them to be easy to open but only at the point of use. Not during production or delivery,

The ability to produce precise cutting by using digitally driven lasers allows us to make customized perforations simple and effective. The result? Visually attractive zippers that open easily while sealing well. And a smoother edge left behind once opened.

You have to try them to see the potential. If you click on the button below, and fill out the form, we will send you this zipper sheet to test for yourself.



Take Me There



Upcoming Events

KOMORI

Komori Packaging Experience Days, Utrecht (NL), May 16-17, 2018

Visitors to the Komori Packaging Experience Days in Utrecht will be able to see the Highcon Euclid III



FESPA Digital Corrugated Experience MESSE BERLIN May 15-18 2018

At the Highcon booth Hall 5.2 Booth D-21 visitors will be able to see the range of

digital cutting and creasing machine in action in live demos.

To learn more please click below

Take Me There



Xeikon Cafe North America 2018 Westin Chicago Northwest, Itasca, Illinois 60143
May 15-17, 2018

Your chance to meet the Highcon team and learn more about how digital finishing goes hand in hand with digital printing, improving efficiency and opening up a whole world of new applications.

Take Me There



corrugated applications made possible with the newly launched Highcon Euclid IIIC.

To learn more about the show, please click below

Take Me There



Dscoop - Unleashing Print Inspirational Experience, Vienna, Austria, June 13 - 15.

Next month you can catch us at Dscoop Vienna. This is your chance to see how digital printing needs digital finishing to avoid bottlenecks. Come see us June 13-15th in Vienna.

Lots more news next month. Till then,

Best regards
The Highcon Team



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